QX500[™] AUTOMATED OPTICAL INSPECTION SYSTEM

OPTIMUM PERFORMANCE AT ASTONISHING SPEED

The QX500[™] embraces CyberOptics' unique image acquisition solution – Strobed Inspection Module (SIM) and is capable of inspecting 01005 components and larger at 200cm²/sec, securely positioning itself as the fastest area-scanning Automated Optical Inspection system in the industry.



The QX500[™] uses white strobed lighting, that consists of dual fixed angle lighting providing a superb image for defect review. You can further enhance component features by choosing a combination of lighting.

QX500[™] is designed to provide the IDEAL platform that can be integrated in assembly lines which manufacture memory modules, notebook PCs, mobile phones, automotive products, and other industrial electronic assemblies.

| Measurement Technique | High Performance | Simple Programming |
|---|---------------------|-----------------------|
| Pattern Matching | × | |
| Algorithm Based | | × |
| CyberOptics′ SAM [™] Software | \checkmark | |

EDGE FOR INSPECTING "ANYTHING"

PROGRAMMING – SIMPLE, PORTABLE



QX500 has taken a quantum leap in comparison to other AOI system performances in the market by combining the SIM and CyberOptics' patented SAM™ (Statistical Appearance Modeling) software. This dual advantage enables QX500 to help you inspect the most comprehensive list of features and detect the widest variety of defect types including defects that you least expected.



Components Inspected / Detected

Programming is as simple as it can get – just draw a box, train SAM[™] with a few good examples, and you are ready to inspect any component, solder joint or feature. Unlike other AOI systems, there are no parameters to adjust and no algorithms to select or tune. You can reduce false-calls significantly over time by simply adding images to the model.

The central model repository is designed to support hassle-free sharing of component models and assembly programs between systems or even between manufacturing sites. SAM[™] Software: Unique Image Processing Technique



SAM[™] Software: Modeling

OYBEROPTICS[°]

QX500

QX500



| INSPECTION CAPABILITIES | QX500 | QX500-L | |
|--|---|--|--|
| Typical Scanning Speed | 200 cm ² /sec (31 in. ² /sec) | | |
| Minimum Component Size | 0402 mm (01005 in.) | | |
| Board Width | 50 mm to 308 mm (2.0 in. to 12.0 in.) | 50 mm to 510 mm (2.0 in. to 20.0 in.) | |
| Board Length (without re-inspection) | 50 mm to 457 mm ⁺ (2.0 in. to 18.0 in.) | 50 mm to 510 mm ⁺ (2.0 in. to 20.0 in.) | |
| Board Thickness | 1 mm to 5 mm | | |
| Component Height Clearance (Max.) | Top: 30 mm (1.18 in.), Bottom: 30 mm (1.18 in.) | | |
| Board Edge Clearance (Min.) | 3.0 mm (0.125 in.), bottom side only | | |
| Component Types Inspected | Standard SMT (chips, J-lead, gull-wing, BGA, etc.), through-hole, odd-form, clips, connectors, | | |
| | header pins, and others | | |
| Component Defect Categories | Missing, polarity, tombstone, billboard, flipped, wrong part, gross body and lead damage, | | |
| | and others | | |
| Solder Joint Defect Categories | Solder bridge, opens, lifted leads, wettability, excess and insufficient solder, debris, and others | | |
| Other Items Detected | Gold-finger contamination, pin-in-hole, bent pins, debris, and many others | | |
| Component Measurement Categories | Component X, Y position, and rotation | | |
| Measurement Gage R&R | <10% (down to 0402 mm components) | | |
| t With re-inspection support the hoard len | ath will be limited to 386 mm | | |

With re-inspection support, the board length will be limited to 386 mm

* With re-inspection support, the board length will be limited to 253 mm and can be extended to 510 mm using conveyor extension kit

| VISION SYSTEM | | | | |
|-------------------------|---|--|--|--|
| Imagers | Multiple 5.0 Megapixel color CMOS cameras | | | |
| Image Transfer Protocol | PCIe | | | |
| Lighting | Strobe white light (with dark/bright field) | | | |
| Resolution | 17µm pixel size | | | |
| Image Processing | Statistical Appearance Modeling (SAM [™]) technology | | | |
| Board Warp Compensation | Up to ± 7 mm | | | |
| Programming | Simple on-line or off-line | | | |
| Programming Instruction | Quick-Start programming guide for easy initial setup | | | |
| CAD Import | Any column separated text file (standard information required – ref. designator, XY, angle, part no.) | | | |



QX500

QX500-L

SYSTEM SPECIFICATIONS

| Conveyor Height | Adjustable to 832 – 990 mm (33 – 39 in.) | | | |
|----------------------|---|--|--|--|
| Machine Interface | SMEMA, RS232 and Ethernet | | | |
| Alarms | Light pole and audible alarm | | | |
| Power Requirements | 100 – 120V 60Hz or 220 – 240V 50Hz, 10 amp max. | | | |
| System Dimensions | 100 x 127 x 139 cm | | | |
| Weight | ~ 410 kg (904 lbs.) | | | |
| Machine Installation | <1 hour | | | |
| | | | | |

OPTIONS

SPC Software, Offline Defect Rework Station, Cross-mount Board Detection Kit, Barcode Readers (1D/2D), Sensor Alignment Target, Dual Monitor Kit, 300 mm Conveyor Extension Kit

FRONT





| Americas | Asia Pacific | China | Еигоре |
|----------------------------|-----------------------|---------------------------------|----------------------------|
| CyberOptics Corporation | CyberOptics Singapore | CyberOptics China Company, Ltd. | CyberOptics Ltd. |
| Minneapolis, Minnesota USA | Singapore | Shanghai | United Kingdom |
| Tel: + 1 763 542 5000 | Tel: + 65 6744 3021 | Tel: + 86 21 6468 8080 | Tel: + 44 (0) 1756 700 330 |

info@cyberoptics.com

• Y B E R • P T I C S www.cyberoptics.com

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